

2011 PLASTICS RESEARCH REVIEW .....	XXI
INTRODUCTION .....	XXI
CHAPTER ONE: CONDUCTIVE POLYMERS: TECHNOLOGIES AND GLOBAL MARKETS (PLS043C) .....	1
INTRODUCTION .....	1
STUDY GOALS AND OBJECTIVES .....	1
REASONS FOR DOING THE STUDY.....	1
SCOPE OF THE STUDY .....	2
METHODOLOGY.....	3
ANALYST CREDENTIALS .....	3
RELATED BCC REPORTS.....	3
BCC ONLINE SERVICES .....	4
DISCLAIMER.....	4
SUMMARY .....	4
<i>TABLE 1 GLOBAL MARKET FOR ELECTROACTIVE POLYMERS, THROUGH 2016 (MILLION LBS/\$ MILLIONS)</i> .....	5
<i>FIGURE 1 GLOBAL MARKET FOR ELECTROACTIVE POLYMERS, 2010–2016 (\$ MILLIONS)</i> .....	6
ELECTROACTIVE POLYMERS.....	7
BACKGROUND .....	7
INHERENTLY CONDUCTIVE POLYMERS .....	8
INHERENTLY DISSIPATIVE POLYMERS (IDPS) .....	8
CONDUCTIVE PLASTICS.....	9
ADDITIONAL TECHNICAL DETAILS.....	9
SYNTHESIZING CONJUGATED POLYMERS.....	10
TECHNIQUES FOR MAKING PLASTICS CONDUCTIVE.....	10
<i>TABLE 2 HOW TO MAKE PLASTICS CONDUCTIVE</i> .....	11
CONCEPT OF RESISTIVITIES .....	11
OVERVIEW .....	11
<i>TABLE 3 RESISTANCE SPECTRUM FOR METHODS OF MAKING PLASTICS CONDUCTIVE</i> .....	11
CONCEPTS AND NOMENCLATURE .....	12
BARRIERS TO APPLICATIONS .....	13
CATEGORIZING ICPS .....	13
<i>TABLE 4 CATEGORIZING INHERENTLY CONDUCTIVE POLYMERS</i> .....	13
ICP HISTORICAL PERSPECTIVE .....	13
PRIOR TO 1990.....	13
POST-1990 PERIOD .....	14
BY 2010.....	15
TECHNOLOGIES .....	16
OVERVIEW .....	16
PREPARATION OF ICPS.....	16
ENERGY BAND STRUCTURE.....	16

CHAIN STRUCTURE .....	17
COMPARISON OF CONDUCTIVITIES OF ICPS WITH METALS, SEMICONDUCTORS, AND INSULATORS .....	18
<i>TABLE 5 CONDUCTIVITIES OF DOPED ICPS COMPARED WITH METALS, SEMICONDUCTORS, AND INSULATORS</i> .....	18
<i>TABLE 5 (CONTINUED)</i> .....	19
DOPING DETAILS .....	19
Background .....	19
Overview .....	19
Chemical and Electrochemical Methods.....	20
Reversal of Doping Process.....	20
Types of Dopants .....	20
Goal of Narrow Band Gaps .....	21
Effect on Color and Optical Properties .....	21
<i>TABLE 6 COLOR OF DOPED AND UNDOPED CONDUCTIVE POLYMERS</i> .....	21
IMPORTANCE OF MOLECULAR WEIGHT AND DISTRIBUTION IN CONDUCTIVE POLYMERS.....	22
IMPROVING HIGH TEMPERATURE CONDUCTIVITY AND TEMPERATURE STABILITY .....	22
ALLOYING AND BLENDING CONDUCTIVE POLYMERS WITH CONVENTIONAL RESINS .....	22
PERFORMANCE ENHANCEMENTS SOUGHT THROUGH ICPS.....	23
Conductivity.....	23
Electrochromic Effects.....	23
Electroluminescence .....	24
Photoconductivity .....	24
Thermochromic Effects.....	24
PROCESSING CONDUCTIVE POLYMERS.....	25
Background .....	25
Problems and Challenges .....	25
Processing Options for ICPs.....	26
<i>TABLE 7 ICP PROCESSING TECHNIQUES</i> .....	26
<i>TABLE 8 STABILITY AND PROCESSING ATTRIBUTES OF KEY ICPS</i> .....	26
 CHAPTER TWO: WOOD-PLASTIC COMPOSITES: TECHNOLOGIES AND GLOBAL MARKETS (PLS034B) .....	
INTRODUCTION .....	27
REASONS FOR DOING THE STUDY.....	27
SCOPE OF THE STUDY .....	27
METHODOLOGY AND INFORMATION SOURCES.....	28
AUTHOR CREDENTIALS .....	28
RELATED BCC REPORTS.....	28
EXECUTIVE SUMMARY.....	28

<i>TABLE 9 GLOBAL MARKET FOR APPLICATIONS OF WPCS, CELLULOSICS, PLASTIC LUMBER, AND NATURAL FIBER COMPOSITES, THROUGH 2016 (METRIC TONS)</i> .....	29
<i>FIGURE 2 GLOBAL MARKET FOR APPLICATIONS OF WPCS, CELLULOSICS, PLASTIC LUMBER, AND NATURAL FIBER COMPOSITES, 2008–2016 (METRIC TONS)</i> .....	30
INDUSTRY OVERVIEW .....	30
DEFINITIONS .....	30
DEFINITIONS (Continued) .....	31
WOOD PLASTIC COMPOSITES.....	32
OVERVIEW .....	32
INTERACTION OF TWO DIFFERENT INDUSTRIES.....	32
THE BEGINNING .....	33
1990 ACTIVITIES .....	33
IMPACT OF USDA AND FOREST PRODUCT COMPANIES.....	33
CONTRAST WITH PLASTIC LUMBER.....	34
CELLULOSICS.....	34
NATURAL FIBER COMPOSITES.....	35
BACKGROUND .....	35
TYPES OF FIBERS.....	36
OUTLOOK.....	36
TECHNIQUES .....	36
PLASTIC LUMBER.....	37

CHAPTER THREE: COMPOSITES: RESINS, FILLERS, REINFORCEMENTS, NATURAL FIBERS AND NANOCOMPOSITES (PLS029C).....	38
INTRODUCTION .....	38
REASONS FOR DOING THE STUDY.....	38
SCOPE OF THE STUDY .....	38
METHODOLOGY.....	39
ABOUT THE AUTHOR .....	40
RELATED BCC REPORTS.....	40
SUMMARY.....	40
<i>TABLE 10 NORTH AMERICAN FIBER REINFORCED PLASTIC MARKET BY APPLICATION, THROUGH 2015 (MILLION LBS)</i> .....	40
<i>FIGURE 3 NORTH AMERICAN FIBER REINFORCED PLASTIC MARKET BY APPLICATION, 2009–2015 (MILLION LBS)</i> .....	41
FILLERS AND REINFORCEMENTS .....	42
BACKGROUND .....	42
PROPERTY PROFILES.....	43
CHARACTERISTICS OF FILLERS/REINFORCEMENTS.....	43
<i>TABLE 11 PROFILE OF CHARACTERISTICS OF FILLERS/REINFORCEMENTS</i> .....	43

<i>TABLE 12 OVERVIEW OF CHARACTERISTICS AND APPLICATIONS OF FILLERS/REINFORCEMENTS</i> .....	44
FILLER/REINFORCEMENT USAGE WITH SPECIFIC RESINS .....	45
<i>TABLE 13 FILLER/REINFORCEMENT USAGE WITH SPECIFIC RESINS</i> .....	45
<i>TABLE 13 (CONTINUED)</i> .....	46
FILLERS .....	46
OVERVIEW .....	46
ALUMINA TRIHYDRATE (ATH) .....	46
Background .....	46
Properties .....	47
Grades .....	47
A Recent Development .....	47
BARIUM SULFATE.....	47
CALCIUM CARBONATE .....	48
Background .....	48
Grades .....	48
As Plastic Fillers.....	48
Automotive Applications .....	49
CALCIUM SULFATE .....	49
Background .....	49
Applications .....	49
KAOLINS.....	49
Background .....	49
Grades .....	50
Automotive Applications .....	50
REINFORCEMENTS .....	50
OVERVIEW .....	50
NON-FIBROUS.....	51
Talcs .....	51
Background .....	51
Grades .....	52
Applications.....	52
Mica .....	52
Background .....	52
Properties .....	53
Applications.....	53
Thermosets .....	53
Thermoplastics .....	53
Wollastonite .....	54
Background .....	54
Applications.....	54
Silicas .....	55

FIBROUS.....	55
Background .....	55
Reinforcement Types .....	55
Overview.....	55
Mats .....	56
Woven Fabrics.....	56
Knitted Fabrics .....	56
Braids .....	56
Preforms .....	56
Glass-Fiber Reinforcements.....	56
Production .....	56
Types of Fiberglass .....	57
Background .....	57
Types of Glass Fibers.....	57
Sizing.....	58
Microspheres .....	58
Background .....	58
Solid Microspheres.....	58
Hollow Microspheres.....	59
<i>TABLE 14 ADVANTAGES OF SOLID GLASS MICROSPHERES.....</i>	<i>59</i>
Applications.....	59
New Development.....	59
Glass Fiber Suppliers .....	60
<i>TABLE 15 GLASS FIBER SUPPLIERS.....</i>	<i>60</i>
Carbon Fibers .....	60
Background .....	60
Manufacture.....	61
Product Types .....	62
Applications.....	62
Largest Users of Carbon Fiber Reinforced Plastics .....	62
The Military.....	62
Commercial Aircraft .....	63
Producers.....	63
Recent Developments.....	63
Usage in Non-Sports Cars .....	63
BMG Developments .....	63
Metallized Carbon Fibers .....	64
End-of-Life Recycling.....	64
Aramid Fibers.....	64
Background .....	64
Production .....	65
Properties .....	65
Usage.....	65
Ceramic Fibers.....	65

Background .....	65
Applications.....	66
Suppliers .....	66
Boron Fibers.....	66
Stainless Steel Fibers .....	67
Natural Fibers .....	67
Background .....	67
Background (Continued).....	68
Types of Natural Fibers .....	69
Overview .....	69
Flax Fibers.....	69
Jute Fibers.....	69
Kenaf Fibers .....	69
Hemp Fibers.....	70
Global Cultivation of Selected Natural Fibers .....	70
<i>TABLE 16 GLOBAL PRODUCTION OF SELECTED NATURAL FIBERS.....</i>	<i>70</i>
Processing.....	71
Comparison with Glass Fibers .....	71
Pricing .....	72
Review of Possible Stumbling Blocks to Natural Fiber Reinforcements .....	72
Suppliers of Natural Fibers.....	72
Composite Products .....	72
Flexform Technologies .....	72
Quadrant Plastic Composites.....	73
Automotive Applications .....	73
Overview .....	73
Recent Developments.....	73
Other Potential Applications.....	74
New Advances .....	74
Sabic IP.....	74
In-Line Compounding and Molding of Biocomposites .....	74
Use of Sunflower Hull Fibers .....	74
Bamboo Fiber Reinforcement Usage .....	75
RheTech Introduces Biocomposite .....	75
Market Estimates and Forecasts .....	75
NANOCOMPOSITES .....	76
BACKGROUND .....	76
CHARACTERISTICS.....	76
BENEFITS.....	77
MECHANICAL ASPECTS.....	77
PROCESSES .....	77
EARLY WORK WITH PLASTICS.....	78

APPLICATIONS.....	78
CARBON NANOTUBES.....	79
NANOCOMPOSITE SUPPLIERS.....	80
<i>TABLE 17 SELECTED NANOCOMPOSITE SUPPLIERS</i> .....	80
<i>TABLE 17 (CONTINUED)</i> .....	81
RECENT NANOCOMPOSITE CONFERENCE.....	81
 CHAPTER FOUR: EMI/RFI: MATERIALS AND TECHNOLOGIES	
(PLS005J) .....	82
INTRODUCTION .....	82
STUDY OBJECTIVES .....	82
SCOPE AND FORMAT.....	82
METHODOLOGY.....	83
CONTRIBUTION OF THE STUDY.....	83
ANALYST CREDENTIALS .....	83
RELATED BCC REPORTS.....	84
SUMMARY.....	84
<i>TABLE 18 GLOBAL EMI/RFI SHIELDING BY METHOD, THROUGH</i> <i>2016 (\$ MILLIONS)</i> .....	85
<i>FIGURE 4 GLOBAL EMI/RFI SHIELDING BY METHOD, 2010–2016 (\$</i> <i>MILLIONS)</i> .....	85
SHIELDING TECHNOLOGIES AND MATERIALS.....	86
OVERVIEW .....	86
FARADAY CAGES/SHIELDS .....	87
COST AND PERFORMANCE CHARACTERISTICS OF THE	
SHIELDING OPTIONS.....	87
COST COMPARISONS.....	88
<i>TABLE 19 TOTAL RAW MATERIAL AND LABOR COSTS ASSOCIATED</i> <i>WITH THE MAJOR SHIELDING OPTIONS</i> .....	88
<i>TABLE 20 RELATIVE COST STRUCTURE OF VARIOUS SHIELDING</i> <i>OPTIONS (\$/LB)</i> .....	89
PERFORMANCE COMPARISONS .....	89
<i>TABLE 21 SUMMARY OF STRENGTHS AND WEAKNESSES OF KEY</i> <i>EMI SHIELDING OPTIONS</i> .....	90
<i>TABLE 22 QUALITATIVE RATINGS OF THE MAJOR SHIELDING</i> <i>OPTIONS</i> .....	90
<i>TABLE 22 (CONTINUED)</i> .....	91
EMC SHIELDING NEEDS TO KEEP UP WITH END-USER	
REQUIREMENTS .....	91
METALLIZATION PROCESSES.....	91
BACKGROUND .....	91
OVERVIEW .....	92
METALLIZATION MATERIALS .....	92
<i>TABLE 23 METALLIZATION MATERIALS—FUNCTIONAL COATING</i> .....	92
SHIELDING EFFECTIVENESS OVERVIEW BY TYPE OF COATING .....	92

<i>TABLE 24 SHIELDING EFFECTIVENESS OF KEY COATINGS.....</i>	<i>93</i>
CONDUCTIVE PLASTICS.....	93
OVERVIEW .....	93
BACKGROUND .....	93
FORMULATION OPTIONS .....	94
HOW DO CONDUCTIVE PLASTICS WORK?.....	95
DIELECTRIC PROPERTIES OF PLASTICS .....	95
<i>TABLE 25 DIELECTRIC CONSTANTS FOR SELECTED MATERIALS.....</i>	<i>96</i>
TECHNIQUES FOR MAKING PLASTICS CONDUCTIVE.....	97
<i>TABLE 26 HOW TO MAKE PLASTICS CONDUCTIVE.....</i>	<i>97</i>
TYPES OF CONDUCTIVE MATERIALS.....	97
<i>TABLE 27 SURFACE RESISTIVITY FOR ELECTRONIC DEVICE</i>	
<i>SUBSTRATES.....</i>	<i>97</i>
<i>TABLE 28 RESISTANCE SPECTRUM FOR METHODS OF MAKING</i>	
<i>PLASTICS CONDUCTIVE.....</i>	<i>98</i>
FUNCTIONS.....	99
CONDUCTIVE ADDITIVE SELECTION.....	99
CONDUCTIVITY TESTS.....	99
REVIEW OF ADVANTAGES AND DISADVANTAGES .....	99
COMPOUNDING CONDUCTIVE PLASTICS .....	100
EXAMPLES OF COMPANIES PRODUCING CONDUCTIVE	
PLASTICS .....	101
<i>TABLE 29 SELECTED KEY COMPANIES PRODUCING CONDUCTIVE</i>	
<i>PLASTICS.....</i>	<i>101</i>
CONDUCTIVE PLASTIC ADDITIVES .....	102
Overview .....	102
Background .....	102
Fibers and Powders .....	102
Silver Coatings.....	103
Carbon Fibers and Powders .....	103
Overview.....	103
Carbon Fibers.....	103
Carbon Blacks .....	104
Metal Fibers.....	105
Overview.....	105
Advantages.....	105
Metal Fiber Conductivity .....	106
Metallized Glass Fibers .....	106
Nickel-Coated Graphite Fibers .....	106
Background .....	106
Advantages .....	107
Stainless Steel Fibers .....	108
Overview .....	108
Technology .....	108



	Effect on Processing .....	109
	Fiber Forms .....	109
	Advantages and Disadvantages .....	110
<i>TABLE 30 ADVANTAGES AND DISADVANTAGES OF STAINLESS</i>		
<i>STEEL FIBERS</i> .....		111
	Copper Fibers .....	111
	Conductive Filler Suppliers.....	111
<i>TABLE 31 SELECTED MAJOR CONDUCTIVE FILLER SUPPLIERS</i> .....		111
<i>TABLE 31 (CONTINUED)</i> .....		112
CARBON NANOTUBES .....		112
Overview .....		112
Usage in Producing Electrically Conductive Composites .....		113
Overview.....		113
Technical Problems.....		114
Carbon Nanotube Producers/Suppliers .....		114
<i>TABLE 32 SELECTED KEY SUPPLIERS OF CARBON NANOTUBES</i> .....		114
New Developments in Carbon Nanotubes.....		114
BASF Introduces Conductive Plastics Using		
Carbon Nanotubes.....		114
Hyperion New Applications.....		115
Aerospace Applications.....		115
Eikos Receives Funds for U.S. Navy Research.....		115
Nanocomp Technologies Secures Air Force Contract....		115
Other Brief Developments Related to Carbon		
Nanotube-Based Electromagnetic Compliance		
Include.....		115
CONDUCTIVE PLASTICS TECHNICAL ISSUES.....		116
CONDUCTIVE FILMS .....		117
OVERVIEW .....		117
EXAMPLES OF COMPANY PRODUCTS .....		117
Donatech VCF Series.....		117
Z-Flo Conductive Films .....		118
INHERENTLY CONDUCTIVE POLYMERS.....		118
BACKGROUND .....		118
POTENTIAL APPLICATIONS.....		118
POLYANILINES .....		118
OTHER TYPES OF ICPS .....		119
PRICING.....		119
PROSPECTS .....		119
COMPARISON OF CONDUCTIVITIES OF ICPS WITH		
METALS, SEMICONDUCTORS, AND INSULATORS.....		120
<i>TABLE 33 CONDUCTIVITIES OF DOPED ICPS COMPARED WITH</i>		
<i>METAL, SEMICONDUCTORS, AND INSULATORS</i> .....		120
PROCESSING OPTIONS FOR ICPS.....		120

<i>TABLE 34 CONDUCTIVITIES OF DOPED ICPS COMPARED WITH METALS, SEMICONDUCTORS AND INSULATORS.....</i>	<i>120</i>
<i>TABLE 35 STABILITY AND PROCESSING ATTRIBUTES OF KEY ICPS....</i>	<i>121</i>
RECENT ACTIVITIES AND DEVELOPMENT.....	121
H.C. Starck Activities.....	121
Polyanilines for EMI Shielding.....	121
Other Academic Advances.....	121
CONDUCTIVE ELASTOMERS.....	122
OVERVIEW.....	122
<i>TABLE 36 SHIELDING EFFECTIVENESS OF CONDUCTIVE ELASTOMERS (MEASURED IN DB).....</i>	<i>122</i>
<i>TABLE 37 COMPARATIVE TESTING OF CONDUCTIVE ELASTOMERS FOR GALVANIC CORROSION.....</i>	<i>123</i>
TECHNOLOGY AND APPLICATIONS RELATED TO EMI.....	123
EXAMPLES OF CONDUCTIVE ELASTOMER PRODUCTS.....	124
Conductive Composites—Midway, UT.....	124
Laird Technologies—Chesterfield, MO.....	124
Leader Tech—Tampa, FL.....	124
CONDUCTIVE COATINGS.....	124
INTRODUCTION.....	124
BACKGROUND.....	124
EMI SHIELDING COMPOUNDS COMPARED WITH CONDUCTIVE COATINGS.....	125
<i>TABLE 38 COMPARING EMI SHIELDING COMPOUNDS AND CONDUCTIVE COATINGS BY SEVERAL KEY VARIABLES.....</i>	<i>126</i>
CONDUCTIVE COATING ISSUES.....	126
COMPARISON OF CONDUCTIVE COATINGS.....	127
<i>TABLE 39 COMPARISON OF CONDUCTIVE COATINGS BY CONDUCTIVITY AND SHIELDING EFFECTIVENESS.....</i>	<i>127</i>
PERFORMANCE OF ALTERNATE CONDUCTIVE COATINGS....	127
ADVANTAGES AND DISADVANTAGES.....	128
PROS AND CONS OF CONDUCTIVE COATINGS.....	128
<i>TABLE 40 ADVANTAGES AND DISADVANTAGES OF CONDUCTIVE COATINGS FOR EMI SHIELDING.....</i>	<i>129</i>
CONDUCTIVE COATING COST COMPARISONS.....	129
COATING BINDERS.....	130
SOLVENT-BASED VERSUS WATERBORNE CONDUCTIVE COATINGS.....	130
COPPER, NICKEL, AND SILVER USAGE.....	131
Advantages of Copper versus Nickel.....	131
Advantages of Nickel versus Copper.....	131
Silver.....	132
Summary of Attributes of the Major Metal Combinations Used as Conductive Materials.....	132

ELECTROPLATED COATINGS .....	133
ELECTROLESS PLATING .....	134
BACKGROUND .....	134
OVERVIEW .....	134
ATTRIBUTES.....	135
REVIEW OF TECHNOLOGY DETAILS .....	135
METALS INVOLVED .....	135
TABLE 41 <i>ELECTROLESS PLATING PROCESS</i> .....	136
ADVANTAGES AND DISADVANTAGES.....	136
TABLE 42 <i>ADVANTAGES AND DISADVANTAGES OF ELECTROLESS</i>	
<i>PLATING FOR EMI SHIELDING</i> .....	136
PLASTIC SUBSTRATES.....	137
APPLICATIONS.....	137
TABLE 43 <i>SELECTED APPLICATIONS USING ELECTROLESS</i>	
<i>PLATING FOR EMI SHIELDING</i> .....	137
MULTILAYERS .....	137
TABLE 44 <i>SEQUENCE OF STEPS FOR ELECTROLESS PLATING OF</i>	
<i>PLASTICS</i> .....	138
CHAPTER FIVE: BIODEGRADABLE POLYMERS (PLS025D) .....	139
INTRODUCTION .....	139
STUDY GOALS AND OBJECTIVES .....	139
REASONS FOR DOING THE STUDY.....	139
SCOPE OF REPORT.....	139
SOURCES.....	140
ANALYST CREDENTIALS .....	140
RELATED BCC REPORTS.....	141
SUMMARY.....	141
TABLE 45 <i>GLOBAL BIODEGRADABLE POLYMER MARKET BY</i>	
<i>APPLICATION, THROUGH 2016 (MILLION LBS)</i> .....	141
TABLE 45 (CONTINUED).....	142
FIGURE 5 <i>GLOBAL BIODEGRADABLE POLYMER MARKET BY</i>	
<i>APPLICATION, 2010–2016 (MILLION LBS)</i> .....	142
SUMMARY (CONTINUED) .....	143
BACKGROUND/HISTORICAL.....	144
OVERVIEW .....	144
THE BIOPOLYMER-SYNTHETIC POLYMER GAP .....	144
NICHE MARKETS .....	144
NEW EMPHASIS.....	145
STILL HAVE ENVIRONMENTAL PROBLEMS .....	145
INTEGRATION OF BIODEGRADABLE PLASTICS WITH DISPOSAL	
INFRASTRUCTURE .....	145
EARLY STARCH-BASED MATERIALS .....	146
INTRODUCTION OF COMPOSTABLE BAGS.....	146
EARLY ENTRANTS .....	147

IMPORTANCE OF LOOSE-FILL .....	147
OTHER FACTORS.....	147
BIOPOLYMERS, CONVENTIONAL PLASTICS, AND BIODEGRADABLE PLASTICS.....	148
NATURAL OR SYNTHETIC.....	148
THE MOVE TO RENEWABLE SOURCES.....	149
EXTENDING THE RECYCLING LOOP .....	149
PROCESSING.....	150
PROPERTIES .....	150
DEFINING BIODEGRADABLE POLYMERS .....	150
PUBLIC ATTITUDES .....	151
ENVIRONMENTAL ISSUES.....	152
COMPOSTING.....	152
MARKET ESTIMATES AND FORECASTS.....	153
BACKGROUND .....	153
OVERVIEW.....	153
<i>TABLE 46 GLOBAL BIODEGRADABLE POLYMER MARKET, THROUGH 2016 (MILLION LBS).....</i>	<i>154</i>
<i>FIGURE 6 GLOBAL BIODEGRADABLE POLYMER MARKET, 2010– 2016 (MILLION LBS).....</i>	<i>154</i>
OVERVIEW (CONTINUED).....	155
 CHAPTER SIX: PLASTICS IN ELECTRONIC ENCLOSURES: GLOBAL	
MARKETS (PLS048A) .....	156
INTRODUCTION .....	156
STUDY OBJECTIVES .....	156
REASON FOR DOING STUDY.....	156
SCOPE AND FORMAT.....	157
METHODOLOGY.....	158
ABOUT THE AUTHOR .....	158
RELATED BCC REPORTS.....	158
BCC ONLINE SERVICES .....	158
SUMMARY.....	159
<i>TABLE 47 GLOBAL MARKET FOR RESINS FOR STATIONARY AND MOBILE ENCLOSURES BY TYPE OF ELECTRONIC ENCLOSURE, THROUGH 2017 (MILLION LBS).....</i>	<i>160</i>
<i>FIGURE 7 GLOBAL MARKET FOR RESINS FOR STATIONARY AND MOBILE ENCLOSURES BY TYPE OF ELECTRONIC ENCLOSURE, 2011-2017 (MILLION LBS).....</i>	<i>160</i>
OVERVIEW OF ELECTRONIC ENCLOSURES .....	161
DEFINITIONS .....	161
PLANNING .....	162
FUNCTIONS .....	162
BACKGROUND .....	162
THE EMI ISSUE.....	163

HEAT-MANAGEMENT .....	164
Downsizing.....	164
STILL A COMPETITIVE SCENARIO .....	164
EFFECTS ON PERFORMANCE REQUIREMENTS AND DESIGN.....	165
MATERIAL AND PROCESS SELECTION .....	166
SIGNIFICANCE OF THIN-WALLING ON RESIN SELECTION ...	167
ISSUE OF FLAME-RETARDANCY.....	168
COSTS .....	168
ORGANIZATIONS PUBLISHING STANDARDS FOR ELECTRONIC ENCLOSURES.....	169
NEW DEVELOPMENTS .....	169
Less Plastic and More Metal Enclosures.....	169
Performance Criteria for Electronic Enclosures .....	170
Background .....	170
Comparison of Performance Criteria .....	170
<i>TABLE 48 COMPARISON OF KEY PERFORMANCE CRITERIA FOR   ELECTRONIC ENCLOSURES: METALS VS. PLASTICS .....</i>	<i>171</i>
PROCESS TECHNOLOGY FOR ELECTRONIC ENCLOSURES .....	171
BACKGROUND .....	171
INJECTION-MOLDING.....	171
STRUCTURAL FOAM MOLDING.....	172
THERMOFORMING.....	173
DIFFERENCES IN MOLDING ENCLOSURES FOR MOBILE VS. STATIONARY DEVICES .....	174
Background .....	174
Distinctions between Mobile and Stationary Enclosures .....	174
Other Factors.....	175
EMI ASPECTS .....	175
BACKGROUND .....	175
OVERVIEW OF EMI-SHIELDING.....	176
MECHANISMS OF SHIELDING.....	176
ELECTROMAGNETIC CONTROL (EMC).....	176
THE IMPORTANCE OF SHIELDING .....	177
CONTROLLING EMI .....	177
SHIELDING-EFFECTIVENESS .....	178
<i>TABLE 49 GENERAL RATINGS OF SHIELDING-EFFECTIVENESS.....</i>	<i>179</i>
COST AND PERFORMANCE OF SHIELDING OPTIONS .....	179
USE OF THERMOPLASTICS.....	179
EMI-SHIELDING COMPOUNDS VERSUS COATINGS.....	180
ELECTRONIC INDUSTRY/EMI-SHIELDING INTERFACE.....	180
Background .....	180
Enclosures.....	181
Overview.....	181

Background .....	181
Aesthetics .....	182
EMI Leakage .....	183
Cost Considerations .....	183
Computers and EMI .....	184
Cellular Phones.....	184
Summing Up the Issues of EMI and Shielded Enclosures .....	185
Suppliers of Shielded Enclosures.....	185